









Release Date: 12 December 2019 Version: A1.2

# PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 0402 (1005) 0.5t
- ► Amber (605nm)

N0A29S70







0402 0.5t Series

#### **APPLICATIONS:**

- Backlighting
- Mini Display
- Indication Light
- Switch light
- Dashboard

# **0402 0.5t Series**

### **FEATURES:**

- Package: PCB / CHIP LED Mono Colour Package
- Forward Current: 20mA Forward Voltage (typ.): 2.0V
- Luminous Intensity (typ.): 130mcd@20mA
- Colour: Amber Wavelength: 605nm
- Viewing angle: 140°
- **Materials:** 
  - Die: AlGaInP/GaAs
- Resin: Epoxy (Water Clear) Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- **Grouping parameters:** 
  - Forward voltage
  - Luminous intensity
- Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.5000/reel, ø180mm (7")



# **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	30	mA
Peak Forward Current Duty 1/8@1KHz	I <sub>FP</sub>	125	mA
Reverse Voltage	VR	5	V
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Power Dissipation	P <sub>D</sub>	75	mW
Operating Temperature	T <sub>OPR</sub>	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

# Electrical & Optical Characteristics (Ta=25°C)

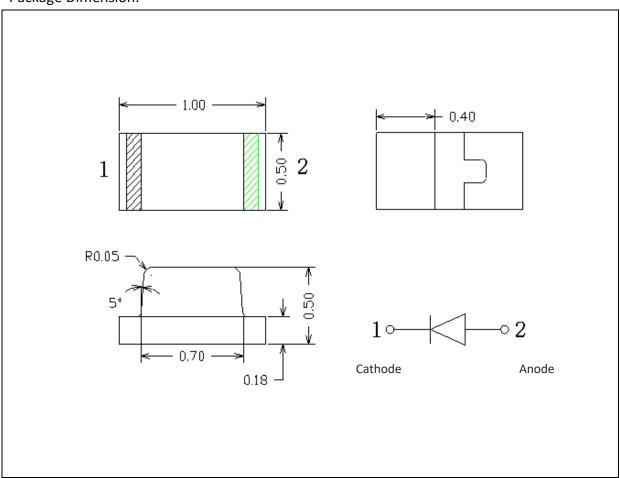
Parameter Symbol		Values			Unit	Test
Parameter Symbol	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V <sub>F</sub>	1.7	2.0	2.5	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	80	130	250	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{D}$	600	605	610	nm	I <sub>F</sub> =20mA
Peak Wavelength	$\lambda_{ extsf{P}}$		615		nm	I <sub>F</sub> =20mA
Spectral Line Half Bandwidth	Δλ		21		nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		140		deg	I <sub>F</sub> =20mA

<sup>1.</sup> Luminous intensity (I $_{V}$ ) ±15%, Forward Voltage (V $_{F}$ ) ±0.1V



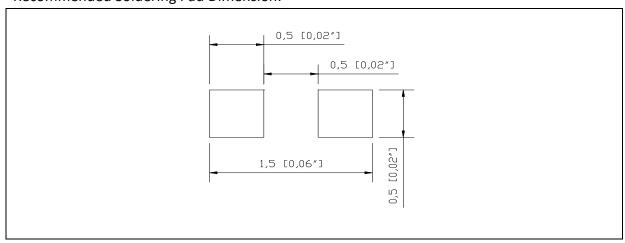
#### **OUTLINE DIMENSION:**

# Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



#### **BINNING GROUPS:**

# Forward Voltage Classifications ( $I_F = 20mA$ ):

Code	Min.	Max.	Unit
	1.7	2.5	V

# Luminous Intensity Classifications (I<sub>F</sub> = 20mA):

Code	Min.	Max.	Unit
I	80	100	
J	100	125	
K	125	160	mcd
L	160	200	
М	200	250	

# Dominant Wavelength Classifications (I<sub>F</sub> = 20mA):

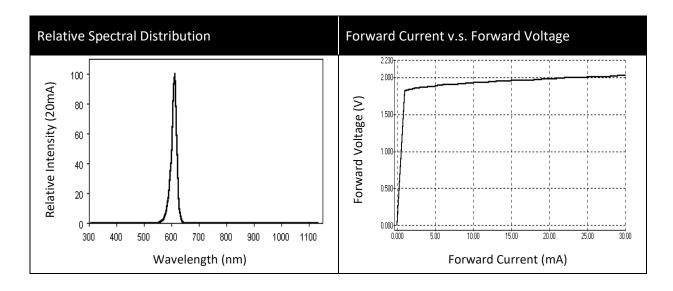
Code	Min.	Max.	Unit
р	600	605	
q	605	610	nm

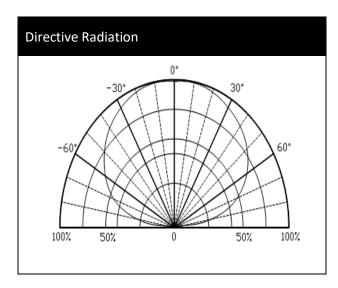
# Example Group Name on Label:

• □Kq20 = □ (1.7~2.5V) ► K (125~160mcd) ► q (605~610nm) ► 20 (IF=20mA)



# **ELECTRO-OPTICAL CHARACTERISTICS:**

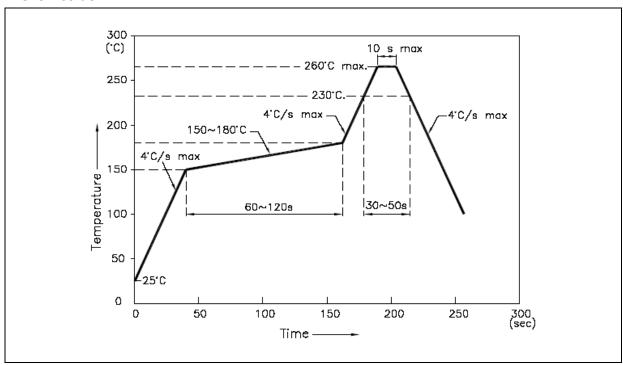






#### **RECOMMENDED SOLDERING PROFILE:**

#### Reflow solder:



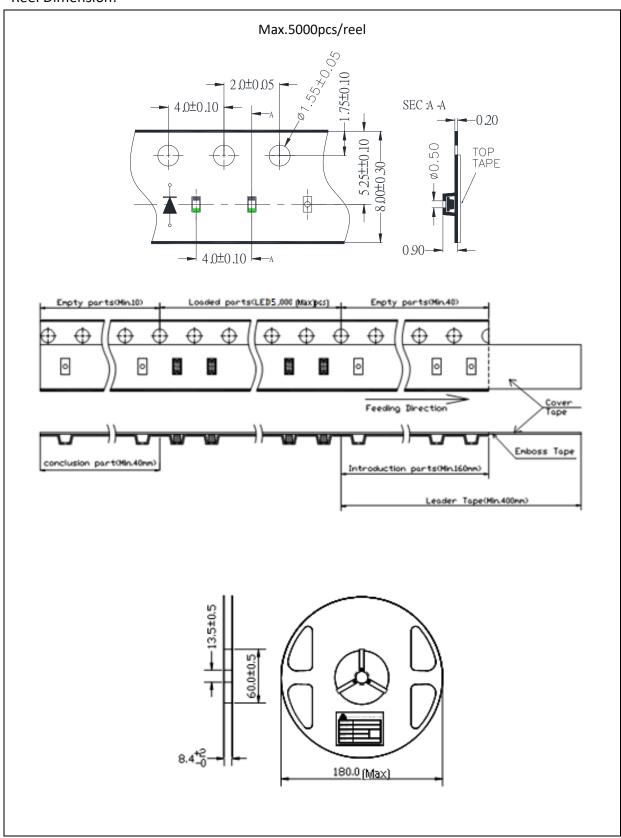
#### Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to  $260^{\circ}\text{C}$
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



#### **PACKING SPECIFICATION:**

#### Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking before use.

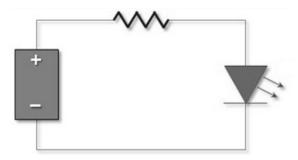
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 72 hours. The suggested baking conditions are as followings:

• 60±3°C x 36hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	26/04/2016	Datasheet set-up.
A1.1	12/12/2019	Revise bin coding.